

# **N-Channel Enhancement Mode Power MOSFET**

### **Description**

The G080N10T uses advanced trench technology to provide excellent  $R_{\rm DS(ON)}$ , low gate charge. It can be used in a wide variety of applications.

#### **General Features**

V<sub>DS</sub> 100V
 I<sub>D</sub> (at V<sub>GS</sub> = 10V) 140A

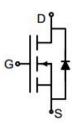
•  $R_{DS(ON)}$  (at  $V_{GS} = 10V$ ) < 7.5mΩ •  $R_{DS(ON)}$  (at  $V_{GS} = 4.5V$ ) < 8mΩ

100% Avalanche Tested

RoHS Compliant

### **Application**

- Power switch
- DC/DC converters



Schematic diagram



TO-220

### **Ordering Information**

Device	Package	Marking	Packaging
G080N10T	TO-220	G080N10	50pcs/Tube

<b>Absolute Maximum Ratings</b> $T_C = 25^{\circ}C$ , unless otherwise noted					
Parameter	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DS</sub>	100	٧		
Continuous Drain Current	I <sub>D</sub>	140	Α		
Pulsed Drain Current (note1)	I <sub>DM</sub>	560	А		
Gate-Source Voltage	$V_{GS}$	±20	V		
Power Dissipation	P <sub>D</sub>	236	W		
Single pulse avalanche energy (note2)	E <sub>AS</sub>	361	mJ		
Operating Junction and Storage Temperature Range	$T_J,T_stg$	-55 To 150	°C		

Thermal Resistance					
Parameter	Symbol	Value	Unit		
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62	°C/W		
Maximum Junction-to-Case	R <sub>thJC</sub>	0.53	°C/W		



			Value			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static Parameters	•		•	•		
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	100			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V			1	μΑ
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS}$ = $\pm 20V$			±100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0	1.8	2.5	V
Drain Course On Decistones	В	$V_{GS} = 10V, I_{D} = 30A$		5.8	7.5	
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 30A		6.4	8.0	mΩ
Forward Transconductance	9 <sub>FS</sub>	$V_{GS} = 5V, I_{D} = 30A$		59		S
Dynamic Parameters				1		
Input Capacitance	C <sub>iss</sub>			13912		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0V$ , $V_{DS} = 50V$ ,		435		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0MHz		363		
Total Gate Charge	$Q_g$	V 50V		192		
Gate-Source Charge	$Q_{gs}$	$V_{DD} = 50V,$ $I_{D} = 30A,$		49		nC
Gate-Drain Charge	$Q_{gd}$	$V_{GS} = 10V$		23		
Turn-on Delay Time	t <sub>d(on)</sub>			32		
Turn-on Rise Time	t <sub>r</sub>	$V_{DD} = 50V$ ,		118		
Turn-off Delay Time	$t_{d(off)}$	$I_D = 30A,$ $R_G = 4.7\Omega$		80		ns
Turn-off Fall Time	t <sub>f</sub>			27		
Drain-Source Body Diode Characte	ristics					
Continuous Body Diode Current	Is	T <sub>C</sub> = 25°C			140	Α
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25^{\circ}C$ , $I_{SD} = 30A$ , $V_{GS} = 0V$			1.2	V
Reverse Recovery Charge	Qrr	I <sub>F</sub> = 30A, V <sub>GS</sub> = 0V		212		nC
Reverse Recovery Time	Trr	di/dt=100A/us		96		ns

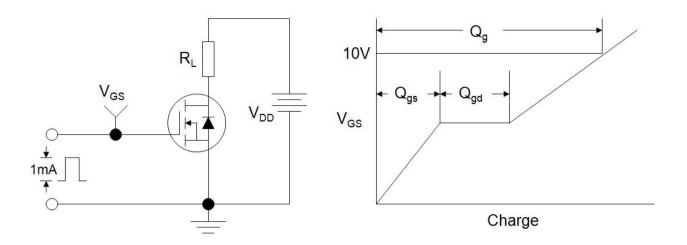
#### Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature

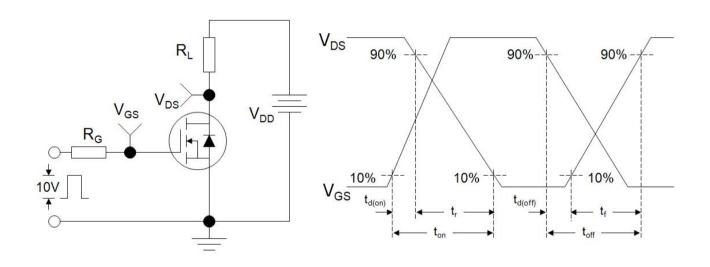
- 2. EAS condition : Tj=25°C ,VDD=50V,VGS=10V,L=0.5mH,Rg=25Ω
- 3. Identical low side and high side switch with identical  $R_{\mbox{\scriptsize G}}$



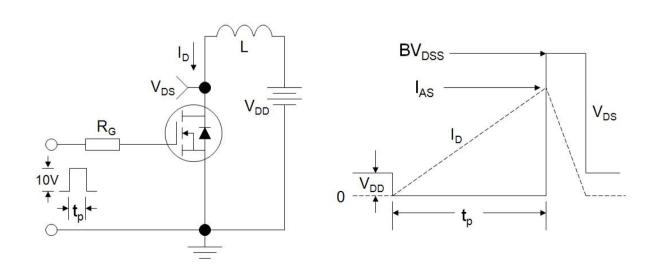
## **Gate Charge Test Circuit**



#### **Switch Time Test Circuit**



**EAS Test Circuit** 





## **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

Figure 1. Output Characteristics

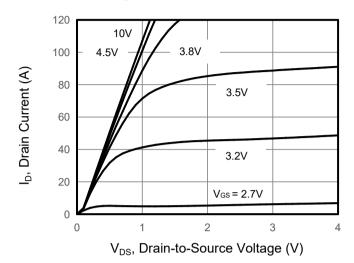


Figure 3. Drain Source On Resistance

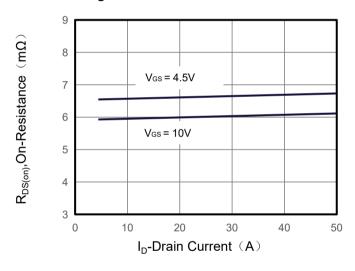
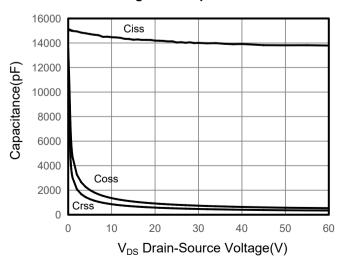


Figure 5. Capacitance



TEL: 0755-29961263

Figure 2. Transfer Characteristics

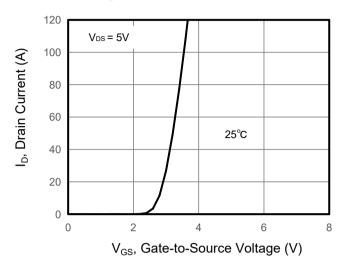


Figure 4. Gate Charge

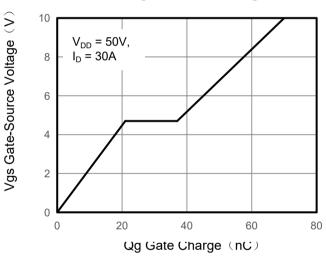
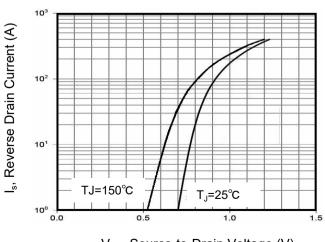


Figure 6. Source-Drain Diode Forward



V<sub>SD</sub>, Source-to-Drain Voltage (V)



# **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

Figure 7. Drain-Source On-Resistance

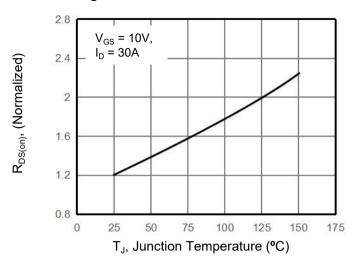


Figure 8. Safe Operation Area

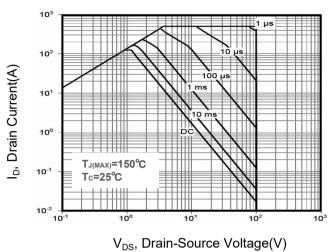
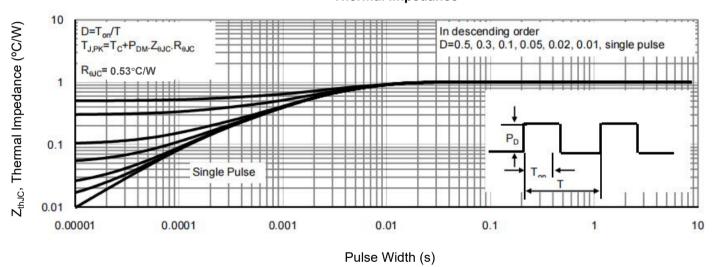
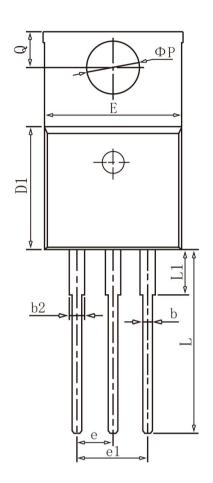


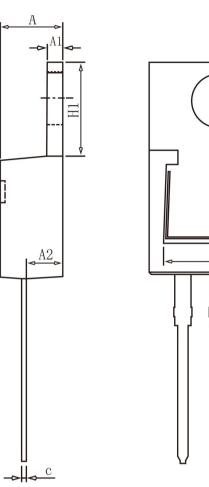
Figure 9. Normalized Maximum Transient Thermal Impedance

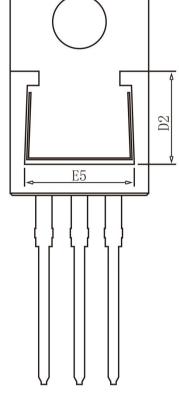




## **TO-220 Package Information**







COMMON DIMENSIONS

SYMBOL	m m			
	MIN	NOM	MAX	
A	4. 37	4. 57	4. 77	
A 1	1. 22	1. 27	1. 42	
A 2	2. 49	2. 69	2. 89	
b	0. 75	0. 81	0.96	
b 2	1. 22	1. 27	1. 47	
С	0. 30	0. 38	0. 48	
D1	8. 50	8. 70	8. 90	
D 2	5. 20	-		
E	9.86	10. 16	10. 36	
E5	7. 06	_	_	
е	2. 54BSC			
e 1	5. 08BSC			
H1	6. 10	6. 30	6. 50	
L	13. 10	13. 40	13. 70	
L1	_	3. 75	4. 10	
ФР	3. 70	3. 84	3. 99	
Q	2. 54	2. 74	2. 94	